

T8534 Quad Programmable Codec and Echo Canceller

Features

- Includes codec, termination impedance, and echo canceller in one device for line card applications
- Programmable μ-law, linear, or A-law PCM input and output (ITU-T G.712 compliant)
- Per-channel programmable gains
- Per-channel programmable internal termination impedance
- Per-channel 64-tap echo canceller (ITU-T G.168 compliant)
- Fully programmable time-slot assignment
- Analog and digital loopback test modes
- Serial microprocessor interface
- Sigma-delta converters with dither to reduce noise
- Six per-channel, bidirectional control pins for SLIC and line card function control
- Quad design to minimize package count on dense line card applications
- Built-in level correction (transmit equalization) to accommodate current-sensing SLICs
- Single 5 V operation

General Description

The quad programmable codec consists of four independent channels of codec and digital signal processing functions on one chip. In addition to the classic A-to-D and D-to-A conversion, the device includes termination impedance synthesis and a 64-tap echo canceller, functionally, on a per-channel basis. The device is capable of meeting all international standards for terminating impedance and digital encoding format. The processing circuitry for the adjustment of the transmit level (equalization) to accommodate current-sensing SLICs is also included.

The device is controlled by a serial microprocessor interface, and a set of bidirectional I/O pins are provided, on a per-channel basis, so that this control mechanism can be utilized to operate the battery feed device, ringing voltage switches, etc. Common data and clock paths can be shared over any number of devices. All the filter coefficients, signal processing, SLIC, and test features are accessible through this interface. This serial interface can be operated at speeds up to 4.096 Mbits/s.

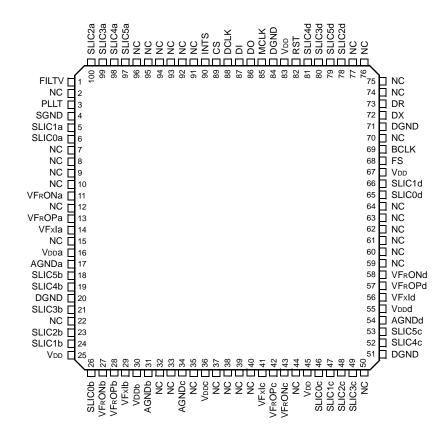
The PCM bus is also programmable, with any channel capable of being assigned to any time slot. The PCM bus can be operated at speeds up to 16.384 Mbits/s, allowing for a maximum of 256 time slots. Separate transmit and receive interfaces are available for 4-wire bus designs, or they can be strapped together for a 2-wire PCM bus.

The device is available in a 100-pin TQFP surfacemount package for economic use of board space.

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Pin Information



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Figure 1. 100-Pin TQFP Pin Diagram

Table 1. Pin Assignments, 100-Pin TQFP, Per-Channel Functions

	Ckt			Name	Туре	Name/Description			
а	b	С	d	IVAILLE	туре	Name/Description			
17	31	34	54	AGND	GND	Analog Ground. A common AGND, DGND, SGND plane is highly recommended.			
16	30	36	55	Vdd	PWR	Analog Power Supply.			
14	29	41	56	VFxI	I	Voice Frequency Transmit Input. This node requires a 10 M Ω or 20 M Ω resistance to AGND. The value is dependent upon the gain of the XAG amplifier (register 146). 20 M Ω can be used for any gain setting, 10 M Ω can only be used for XAG gain settings of 0 dB and 6.02 dB.			
13	28	42	57	VFROP	0	Voice Frequency Receive Output, Positive Polarity. This pin can drive 2000 Ω (or greater) loads.			
11	27	43	58	VFRON	0	Voice Frequency Receive Output, Negative Polarity. This pin can drive 2000 Ω (or greater) loads.			
6	26	46	65	SLIC0	I/O	SLIC Control 0.			
5	24	47	66	SLIC1	I/O	SLIC Control 1.			
100	23	48	78	SLIC2	I/O	SLIC Control 2.			
99	21	49	80	SLIC3	I/O	SLIC Control 3.			
98	19	52	81	SLIC4	I/O	SLIC Control 4.			
97	18	53	79	SLIC5	I/O	SLIC Control 5.			

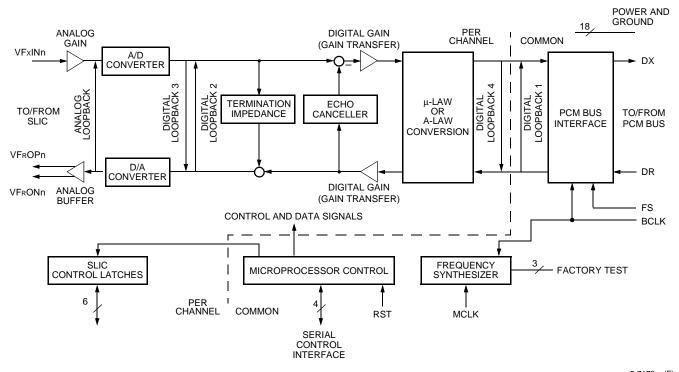
Pin Information (continued)

Table 2. Pin Assignments, 100-Pin TQFP, Common Functions

Pin	Name	Type	Name/Description
1	FILTV	PWR	Frequency Synthesizer Power (5 V). This pin must be tied to VDD.
2, 7—10, 12, 15, 22, 32, 33,	NC	_	No Connect. This pin may be used as a tie point.
35,			
37—40,			
44, 50,			
59—64, 70,			
74—77,			
91—96			
3	PLLT	0	Internal Test Point. Do not connect to this pin.
4	SGND	GND	Synthesizer Ground. Connect to digital ground. A common AGND, DGND, SGND plane is highly recommended.
20, 51, 71, 84	DGND	GND	Digital Ground. Logic ground and return for logic power supply. A common AGND, DGND, SGND plane is highly recommended.
25, 45, 67, 83	Vdd	PWR	Digital Power Supply (5 V).
68	FS	I	PCM Frame Strobe Input. This 8 kHz clock must be derived from the same source as BCLK.
69	BCLK	I	PCM Bit Clock Input. This lead is used to develop internal clocks for certain
			clock rates.
72	DX	0	PCM Transmit Data Output. This is a 3-state output.
73	DR	I	PCM Receive Data Input.
82	RST	I	Power-On Reset. A low causes a reset of the entire chip. This pin may be connected to DGND with a 0.1 μ F capacitor for a power-on reset function, or it may be driven by external logic. This lead has an internal pull-up.
85	MCLK	I	1.024 MHz Master Clock Input. Internal timing is derived from this clock input
			for certain PCM bus rates. See the Clocking Considerations section on
			page 6. When unused, this pin may be left open. This pin has an internal pull-up resistor.
86	DO	0	Serial Data Output. This is a 3-state output.
87	DI		Serial Data Input.
88	DCLK	_	Serial Data Clock Input.
89	CS	I	Chip Select Input. This lead determines the interval that the serial interface is active.
90	INTS	I	Serial Interface Select. Leaving this lead open places the serial interface in the normal mode; grounding it places the interface into the byte-by-byte mode. This lead has an internal pull-up.

Functional Description

Refer to Figure 2 for the following discussion. (It should be noted that much of the processing is performed in a digital processor; thus, the actual data flow may be different than this functional, analog analogy based diagram shows.)



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Figure 2. Functional Block Diagram, Each Section

This device performs virtually all the signal processing functions associated with a central office line termination. Functionality includes line termination impedance synthesis, adaptive or fixed hybrid balance (echo canceller), and level conversion both in the analog sense (transmit equalization), to accommodate various subscriber line interface circuits (SLICs), and in the digital sense, for adjustment of the levels on the PCM bus (gain transfer). In general, the termination impedance synthesis generates the equivalent of a circuit with the parallel combination of a capacitor and a resistor in series with a resistor or the parallel combination of a resistor and the series combination of a resistor and capacitor. These general forms of impedance characteristic will satisfy most of the requirements specified throughout the world. Programmable selection of either μ-law or A-law encoding further aids worldwide deployment. In addition to the programmable features for impedance and coding, the device also contains an echo canceller that meets international requirements for network echo cancellers. This includes the ability to automatically disable the adaptation in the presence of 2100 Hz modem tones. All coefficients used in the filtering algorithms can be computed off-line in advance and downloaded to the device at the time of powerup. All signal processing is contained within the device, and there are only three interfaces of consequence to the system designer: the SLIC interface, the PCM interface, and the control interface.

The SLIC interface is designed to be flexible and convenient to use with a variety of SLIC circuits. With an appropriate choice of SLIC, no external components are required in the interface, with the exception of a dc blocking capacitor in the transmit direction. In some cases, dc blocking capacitors in the receive direction may be necessary as well, since the device operates from a single 5 V supply.

The PCM bus interface is flexible in that it allows, independently, the transmit and receive data for any channel to be placed in any time slot. The bus can be operated at a maximum of a 16.384 Mbits/s rate to accommodate a maximum of 256 time slots. Separate pins are provided for each direction of transmission to allow 4-wire bus operation. The frame strobe signal is an 8 kHz signal that defines the beginning of the frame structure. The interface will count 8 bits per time slot and insert or read the data for each channel as programmed. Lower speeds of the PCM bus are allowed. The PCM clock must be synchronous with the master clock for the device (if present) and with the frame strobe signal.

The microprocessor control interface is a serial interface that uses the classic chip select type of operation. The interface controls the device by writing or reading various internal addresses. The command set comprises simple read and write operations, with the address determining the effect. All the memory locations, including the per-chip functions, are organized by channel, allowing a straightforward migration path to architectures other than quad.

There are several test modes included to facilitate confirmation of correct operation. In the signal path, both an analog and four digital loopback tests are available, while in the microprocessor interface, there is a write/read test mode that tests the operation of the memory. Use of external test access switches allows a complete test of the signal path through the line card so that correct operation of various operational modes can be verified.

Clocking Considerations

This device has several clock inputs for the various interfaces. The PCM bus uses BCLK as the bit clock and the one-going edge of FS to determine the location of the beginning of a frame. These two clocks must be derived from the same source. Internally, the device develops all the internal clocks with a phase-locked loop that uses BCLK as the timing source when BCLK is 16.384, 8.192, 4.096, 2.048, or 1.024 MHz. In these instances, MCLK is not used and may be left open since any signal driving MCLK is ignored. For BCLK rates of 256 kHz and 512 kHz. MCLK is used as a source for the PLL and must be 1.024 MHz. In this latter case, BCLK, MCLK, and FS must be derived from the same source and the rising edge of BCLK must be within 10 ns of the rising edge of MCLK. BCLK, FS, and MCLK (if required) must be continuously present

and without gaps in order for the device to operate correctly. Note that the nominal values in Table 14 are the valid frequencies for BCLK.

DCLK is used to clock the internal serial interface and may be asynchronous to the other clocks. There is no need to derive this clock from the same source as the other clocks. The serial bus may be operated at any speed up to 4.096 Mbits/s. DCLK can be gapped; however, additional clock cycles are required in and around the command frame to process data, and during and after a hardware or a software reset to ensure complete clearing of internal logic. There is no limit on the number of devices on the same serial bus.

The Control Interface

The device is controlled via a series of memory locations accessed by a serial data connection to the external master controller. This interface operates using the chip select lead to enable transmission of information. All chip functions are enabled or disabled by setting or clearing bits in the control memory. Filter coefficients and gain adjustments are also stored in this memory.

The codec has both a serial input lead and a serial output lead. These may be used individually for a 4-wire serial interface, or tied together for a 2-wire interface. The line driver circuitry is capable of driving relatively high currents so that in the event that the line is long enough to show significant transmission line effects, it can be terminated in the characteristic impedance at each end with resistors to Vcc and ground.

All data transfers on the serial bus are byte oriented with the least significant bit (shown in this data sheet as bit 0) transmitted first, followed by the more significant bits. For data fields, the least significant byte of the first data byte is transmitted first, followed by the more significant bytes, each byte transmitted LSB first. This format is compatible with the serial port on most microcontrollers.

Modes

There are two different modes of operation for the serial interface, the normal mode and the byte-by-byte mode. These two modes differ in the manner in which CS is used to control the transfer. Note that the CS lead is used to control the transfer of serial data from master controller to slave codec and in the reverse direction.

The Control Interface (continued)

In normal mode, (INTS pin open) the CS lead must go low for the duration of the transfer. The only error check performed by the codec is to verify that CS is low for an integral number of bytes. Detection of an active (active-low) chip select for other than an integral multiple of 8 bits results in the operation being terminated. The next active excursion of chip select will be interpreted as a new command; hence, the serial I/O interface can always be initialized by asserting CS for a number of clock periods that is not an integral multiple of 8. CS is captured using DCLK, so DCLK must be transitioned to perform this initialization. Undefined command codes are reserved for future use and may cause unwanted operation of the device.

The byte-by-byte mode (INTS pin tied to ground) uses CS to control each byte of the transfer. In this mode, CS goes low for exactly 8 bits at a time, corresponding to a 1-byte transfer either to or from the codec chip. Repeated transitions of CS are used to control subsequent bytes of data to/from the codec. For a write command in this mode, CS must go low for each byte of the transfer until the transfer is complete. For a read command, CS will go low for each of the 3 bytes of the read command transferred to the device, and then low again for each byte to be read. Notice that the total number of bytes transferred (and excursions on CS) is N + 3, where N is the number of bytes to be read in the command. This mode of operation is useful in cases where the master is a microprocessor with a built-in UART that transfers 1 byte at a time. Error detection is limited to detection of an active CS for other than an integral multiple of 8 bits. Recovery is the same as normal mode. Note that the clock phase is shifted in this mode.

Flow control can be accomplished by suspending the transitions on DCLK by holding either state. During the data transfer, CS must remain low while clock transitions are suspended with DCLK in either state.

Protocol

The format of the command protocol is shown in Figures 3 and 4.

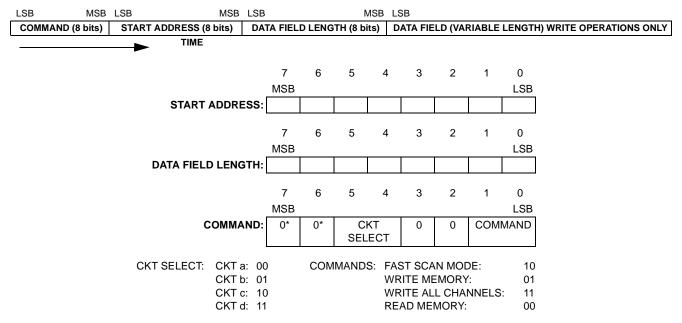
The control interface operates with one external master controller and multiple slave codec devices. Each transfer is initiated by the master, and the slave responds for either read operations or the fast scan mode. The slave does not check the bus for activity prior to transmitting; it only checks for an active CS. The master should allow for a wait between the end of a read command until CS becomes active for the read data. The master must refrain from sending additional commands to the slave chip until the response is received. On a 4-wire bus, commands to other devices may be initiated before the response is received, but care in generating the CS function is needed to ensure that the multiple responses do not interfere. It should be noted that multiple memory locations can be accessed in the same command by setting the data field length field to the desired number of bytes to be transferred. If flow control is desired, it must be performed by using separate commands, each transferring smaller blocks of information, or by controlling the serial clock (gapping the serial clock), or with CS in the case of byte-by-byte mode.

There is no response from the slave to the master for a write operation. The response to a read operation simply includes the data to be read in the data field. This data is sent least significant bit first, with the bytes sent in ascending sequence. Commands from the master controller include data for write operations, but not for read operations. Since the coefficients and gains are stored in volatile memory, all the coefficients and gains must be loaded after powerup. There is, however, no need to reload them when switching from active to standby modes, or vice versa. Great care should be exercised in loading memory when the codec channel is not in standby mode. Sudden changes in the termination or balance impedances can result in undesirable system operation.

All data is transmitted in a byte-oriented fashion with the least significant bit of each byte transferred first. Multibyte fields are transferred least significant byte first in both directions. The data field will contain the first addressed data location first, with subsequent data locations transmitted in ascending order.

The Control Interface (continued)

Protocol (continued)



^{*} Location of memory bank selection. All user controls are in memory bank 0; other memory banks contain internal state information for the device.

Note: Data field length is in bytes for all operations. All data is transmitted in bytes with the LSB for each byte transmitted first. For 16-bit memory operations, the least significant byte of the first memory location is transmitted first, followed by the most significant byte; each byte is transmitted LSB first. Additional memory locations are loaded in ascending sequence.

Figure 3. Command Frame Format, Master to Slave, Read or Write Commands

LSB

DATA FIELD (VARIABLE LENGTH) READ OPERATIONS ONLY

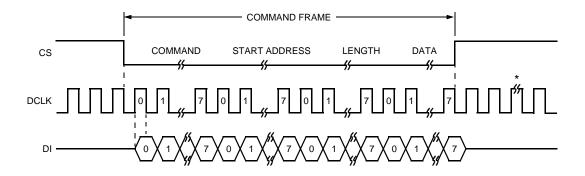
Note: All data is transmitted in bytes with the LSB for each byte transmitted first. For memory operations, the least significant byte of the first memory location is transmitted first, followed by the most significant byte, each byte transmitted LSB first. Additional memory locations are loaded in ascending sequence.

Figure 4. Command Frame Format, Slave to Master, Read Commands

The Control Interface (continued)

Write Command

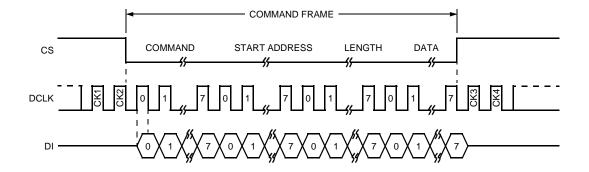
A write command is used to write to the memory addresses. Figures 5—8 illustrate normal or byte-by-byte operation with continuous or gapped DCLKs. For gapped DCLK operation, transitions, not frequency, are critical (as long as transitions occur no faster than 122 ns apart).



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Note: Data field length of 1 shown.

Figure 5. Write Operation, Normal Mode (Continuous DCLK)



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Notes:

Data field length of 1 shown.

CK1 through CK4 are additional DCLK pulses required to properly process the data.

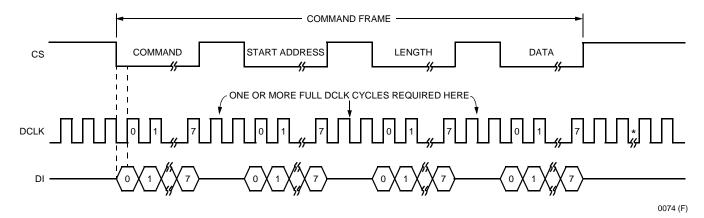
CK3 and CK4 are not necessary if another command frame follows this sequence.

Figure 6. Write Operation, Normal Mode (Gapped DCLK)

^{*} Two or more full DCLK cycles are required before the start of a new command frame.

The Control Interface (continued)

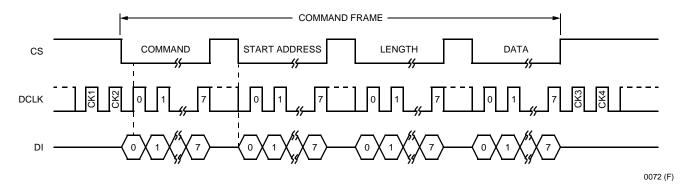
Write Command (continued)



^{*} Two or more full DCLK cycles are required before the start of a new command frame.

Note: Data field length of 1 shown.

Figure 7. Write Operation, Byte-by-Byte Mode (Continuous DCLK)



Notes:

Data field length of 1 shown.

CK1 through CK4 are additional DCLK pulses required to properly process the data.

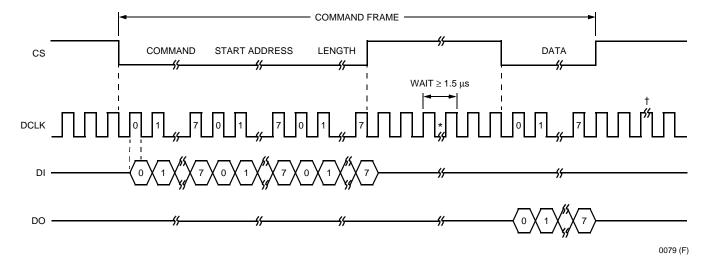
CK3 and CK4 are not necessary if another command frame follows this sequence.

Figure 8. Write Operation, Byte-by-Byte Mode (Gapped DCLK)

The Control Interface (continued)

Read Command

The normal flow of information to the master controller is always in response to a read command. All control memory locations are accessed in 8-bit bytes. All read commands from the master controller require a response from the addressed codec. It is the responsibility of the master controller to ensure that only one device is transmitting on the serial interface line at any one time. The master controller also must ensure that the CS lead goes high after transferring the 3-byte sequence used to initiate the read, and then it goes low again for the response. In this case, it should be noted that the device expects the second time CS goes low that data is to be sent to the master; thus, it does not interpret the DI lead as containing a valid instruction during that CS excursion and a write during this time is not recommended. Note also that the CS lead must allow the number of bytes sent in a read command to be transferred before a subsequent command can be received by the codec. Figures 9—12 illustrate normal or byte-by-byte operation with continuous or gapped DCLKs. Like a write command, transitions, not frequency, are critical with regard to gapped DCLK operation.



^{*} Provide sufficient wait time to access read data. Provide sufficient DCLK cycles to effectively wait ≥ 1.5 µs after the second full DCLK cycle and before the second to last full DCLK cycle. DCLK operation of 4.096 MHz would require 10 cycles of DCLK between LENGTH and DATA. The first two DCLK cycles, when CS goes high, processes the command. A wait is then required to access the read data. Two final DCLK cycles are required to process the read data.

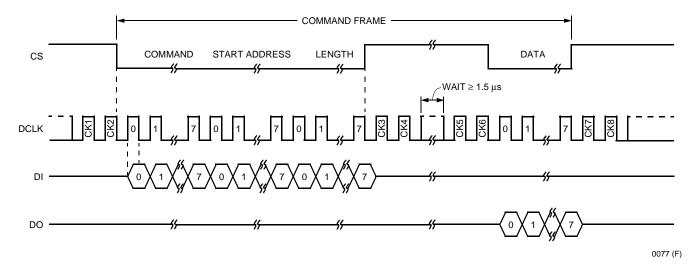
Note: Data field length of 1 shown.

Figure 9. Read Operation, Normal Mode (Continuous DCLK)

[†] Two or more DCLK cycles are required before the start of a new command frame.

The Control Interface (continued)

Read Command (continued)



Notes:

Data field length of 1 shown.

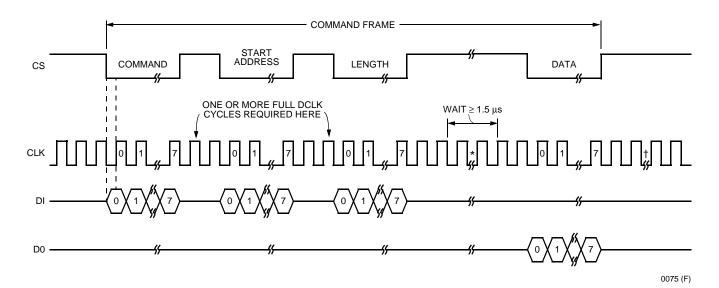
CK1 through CK8 are additional DCLK pulses required to properly process the data.

CK7 and CK8 are not necessary if another command frame follows this sequence.

Figure 10. Read Operation, Normal Mode (Gapped Clock)

The Control Interface (continued)

Read Command (continued)



^{*} Provide sufficient wait time to access read data. Provide sufficient DCLK cycles to effectively wait ≥ 1.5 µs after the second full DCLK cycle and before the second to last full DCLK cycle. DCLK operation of 4.096 MHz would require 10 cycles of DCLK between LENGTH and DATA. The first two DCLK cycles, when CS goes high, processes the command. A wait is then required to access the read data. Two final DCLK cycles are required to process the read data.

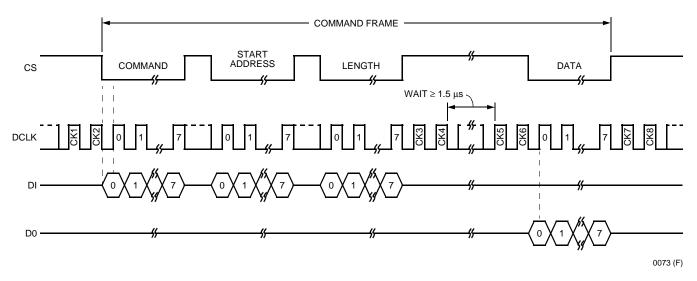
† Two or more DCLK cycles are required before the start of a new command frame.

Note: Data field length of 1 shown.

Figure 11. Read Operation, Byte-by-Byte Mode (Continuous DCLK)

The Control Interface (continued)

Read Command (continued)



Notes:

Data field length of 1 shown.

CK1 through CK8 are additional DCLK pulses required to properly process the data.

CK7 and CK8 are not necessary if another command frame follows this sequence.

Figure 12. Read Operation, Byte-by-Byte Mode (Gapped DCLK)

The Control Interface (continued)

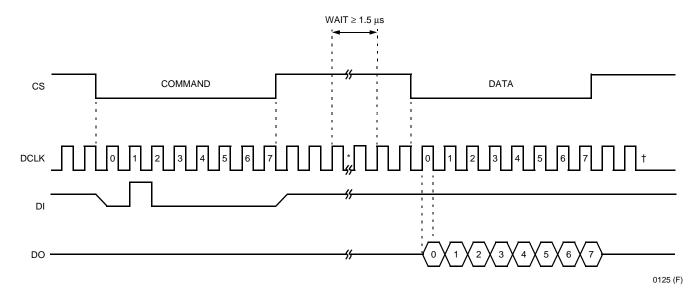
Fast Scan Mode

The fast scan mode allows a single byte command to read two SLIC control leads for all four channels with a 1-byte reply. This mode significantly speeds up the normal scanning for off-hook, ring trip, and ring ground detection. This special command sequence allows the controlling microprocessor to fast scan 2 bits in the SLIC control byte of each of the four channels. The command code is $(00000010)_2$, there are no start address or length fields. The command returns only a single byte of data, formatted as shown in Table 9.

Table 3. Bit Assignments for Fast Scan Mode

Bit	Reported Status
0 (LSB)	Channel 0, bit 0 (ckt a, address 160, bit 0)
1	Channel 0, bit 1 (ckt a, address 160, bit 1)
2	Channel 1, bit 0 (ckt b, address 160, bit 0)
3	Channel 1, bit 1 (ckt b, address 160, bit 1)
4	Channel 2, bit 0 (ckt c, address 160, bit 0)
5	Channel 2, bit 1 (ckt c, address 160, bit 1)
6	Channel 3, bit 0 (ckt d, address 160, bit 0)
7 (MSB)	Channel 3, bit 1 (ckt d, address 160, bit 1)

The circuit select in the command structure (Figure 3) is not used for this special single-byte command. The rules for toggling chip select apply as for the read command. Figures 13—16 illustrate normal or byte-by-byte operation with continuous or gapped DCLKs.



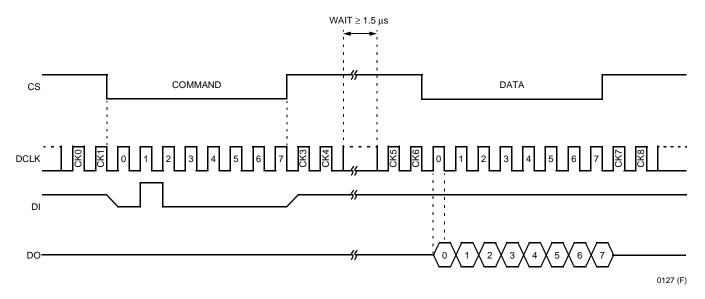
^{*} Provide sufficient wait time to access read data. Provide sufficient DCLK cycles to effectively wait ≥ 1.5 μs after the second full DCLK cycle and before the second to last full DCLK cycle. DCLK operation of 4.096 MHz would require 10 cycles of DCLK between COMMAND and DATA. The first two DCLK cycles, when CS goes high, processes the command. A wait is then required to access the read data. Two final DCLK cycles are required to process the read data.

Figure 13. Fast Scan, Normal Mode (Continuous DCLK)

[†] Two or more DCLK cycles are required before the start of a new command frame.

The Control Interface (continued)

Fast Scan Mode (continued)

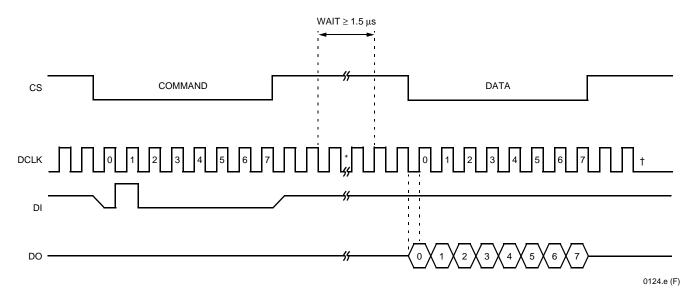


Note: CK1 through CK8 are additional DCLK pulses required to properly process the data.

Figure 14. Fast Scan, Normal Mode (Gapped DCLK)

The Control Interface (continued)

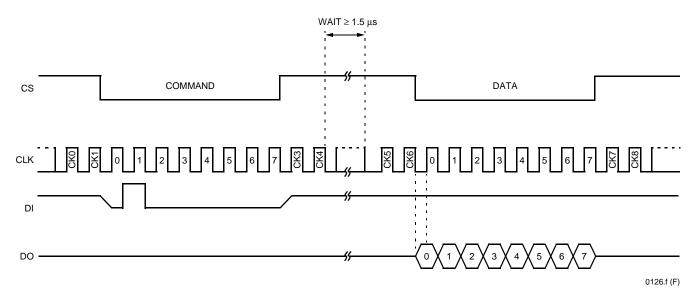
Fast Scan Mode (continued)



^{*} Provide sufficient wait time to access read data. Provide sufficient DCLK cycles to effectively wait ≥ 1.5 μs after the second full DCLK cycle and before the second to last full DCLK cycle. DCLK operation of 4.096 MHz would require 10 cycles of DCLK between COMMAND and DATA. The first two DCLK cycles, when CS goes high, processes the command. A wait is then required to access the read data. Two final DCLK cycles are required to process the read data.

† Two or more DCLK cycles are required before the start of a new command frame.

Figure 15. Fast Scan, Byte-by-Byte Mode (Continuous DCLK)



Note: CK1 through CK8 are additional DCLK pulses required to properly process the data.

Figure 16. Fast Scan, Byte-by-Byte Mode (Gapped DCLK)

The Control Interface (continued)

Write All Channels

The write all channels command causes all four channels to be loaded with the same coefficients with a single data transfer from the master controller. This allows for a faster initialization of the device after a powerup. This command should be used with caution since it affects all four channels. The normal memory write and read commands affect only one channel.

Reset Functionality

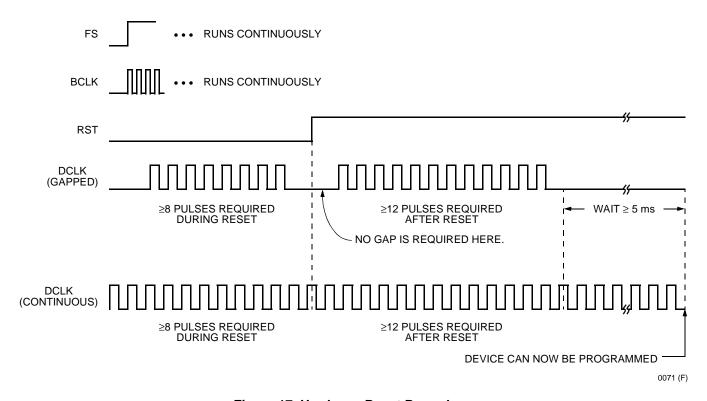


Figure 17. Hardware Reset Procedure

The reset function allows the internal logic of the device to be set to a known initial condition, either externally by activating the reset lead, or on a per-channel basis through the microprocessor interface by setting and then clearing bits, if required, in address RESCTRL (address 128). These two reset functions have different effects, and each of the software reset functions is a subset of the hardware reset functionality. The primary difference is in the treatment of the internal memory. The hardware reset is assumed to be a result of a catastrophic hardware event, such as a loss of power or an initial powerup. Accordingly, the assumption is made that the internal memory does not contain valid data, and default values for all memory locations are loaded. A software reset, however, can only be initiated if the device is operational (at least the microprocessor interface), so the contents of the memory may indeed be valid; thus, the resets may be more specific. Additionally, software resets only affect the selected channel.

Reset Functionality (continued)

A 0.1 μ F capacitor between the RST lead and ground will effectively hold the lead low long enough to reset the device on powerup, allowing for a cost-effective power-on reset function. Notice that the memory must be reloaded through the serial interface after a hardware reset function. For proper operation, it is necessary for FS and BCLK to be present and stable during a reset. DCLK transitions (frequency is not critical as long as the maximum rate is not exceeded) are also required in order for all internal logic to be properly cleared as is a wait period for the internal PLL to stabilize. See the timing diagram shown in Figure 17 for the proper hardware or power-on reset procedure.

For a software reset, the control memory should not be accessed for a minimum of 256 µs following the reset.

Memory Control Mapping

Several memory locations are used to control the device. The Software Interface tables (Table 16, Memory Mapping and Table 17, Control Bit Definition) show the memory assignments that are useful in call processing and system testing. It should be noted that other memory locations are used by the device to hold intermediate results and other device state information. Writing to these other locations can cause serious disruptions in the operation of the device and should be avoided.

Standby Mode

The device enters a low-power standby mode with powerup or software reset, or by programming the CHACTIVE register 129, bit 0. In standby mode, the control interface is active, capable of writing or reading registers. SLIC read and write data latches are also active. Analog signals at VFxI and PCM signals at DR are ignored in this mode. BCLK must be present for proper standby mode operation.

Test Capabilities

The device has several built-in test capabilities that can be used to verify correct operation of the signal processing of the line card. These test functions are accessed in several different control addresses. Five loopback modes are employed (the first four in the list below are digital loopbacks):

- Digital 1. Allows the digital signal from the PCM bus to be looped back to the PCM bus. This loopback facility can be used to verify correct operation of the PCM bus interface logic, as well as operation of the PCM bus.
- Digital 2. Allows complete testing of the digital processing capability of the codec by looping the data back at the analog/digital conversion interface.
- Digital 3. This loopback function is at the digital side of the sigma-delta mode converters and loops analog transmit data back to the analog receive path.
- Digital 4. This loopback is at the PCM bus interface and loops the transmit data from the line back to the receive path.
- Analog 5. The analog loopback facility can be used to check the operation of all the signal processing performed in the device, including the conversions to/from analog.

Three of these loopback functions (digital 1 and 2, and the analog loopback) can be used with tone generation and reception via the PCM bus.

By assigning the transmit and receive time slots identically, a loopback arrangement at the PCM bus can be effectively programmed for signals generated on the line side of the codec. This mode is useful for testing from the line side through the entire device.

An optional 16-bit encoding mode is included on a perchannel basis for use in various test scenarios, or for use by an external digital signal processor. This mode of operation differs from the companded modes in both the bit order and the use of multiple time slots on the PCM bus.

Echo Canceller Functionality

The echo canceller has three sets of coefficient memory storage locations. One, called HPRE, contains the default balance coefficients and can be accessed as memory addresses 0—127. This serves as the coefficients for a fixed balance network (adaptation disabled), or as a starting point for echo cancelllation. The contents of these memory locations do not change with adaptation. The adaptation coefficients, which are added to the corresponding coefficients in HPRE, are stored in the HHAT area. Normally, the user has no need to access these coefficients; thus, these addresses are not described in this data sheet. The HHAT coefficients cover either the first 8, 16, 32, or the entire 64-tap length of the balance filter, depending on the settings in the LMSGAIN address. Note that all echo canceller length options in this control location may not be implemented, but are reserved for future use.

A third set of coefficients is contained in HDTA, which are used for special data call functions.

SLIC Control Capabilities

Memory locations 158, 159, and 160 are used to control six bidirectional latches that are intended to allow the serial interface to control other line card devices. such as ringing/test switches, telecom electromechanical relays, and SLIC devices. When the TTL latches are configured as outputs, external devices should be set up to sink current from the latch. Location 158 sets the operational mode of these latches as either inputs or outputs. Location 159 specifies what is to be written on the latch leads driven by the device. Location 160 reports the actual state of these leads. It should be noted that a channel control reset forces all of these external leads, except those corresponding to bits 2 and 3, to the high-impedance state, so any inputs connected to bits 0, 1, 4, and 5 should have appropriate pull-up or pull-down resistors (off-chip, if required) to force the external device into a known state at powerup or in the event of a reset. Bits 2 and 3 will reset to outputs with a value of zero.

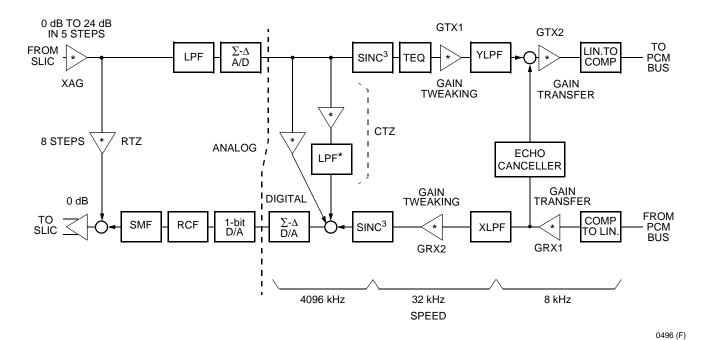
The fast scan mode allows for a minimal data transfer on the serial bus to monitor bits 0 and 1 of the SLIC data memory location (159). If these 2 bits are wired as inputs to the off-hook and/or ring ground detection circuits, a convenient method of rapidly scanning for these two functions is obtained. Bits 2 and 3 default to outputs; thus, they are convenient to provide control of the SLIC state. In any event, all six leads are programmable for maximum flexibility.

Suggested Initialization Procedures

It is suggested that upon powerup, a hardware reset be used to set the device into a known state. The serial interface should then be used to load the memory addresses that differ from the default values (the write all channels command is convenient for this function). If other devices are controlled by the SLIC data memory location, then it also should be loaded with a known configuration. After the completion of this sequence, the device is ready to be activated. Depending on the application, the next step may either be normal operation or a set of test sequences. After the initialization of the memory, the device and associated line card devices can be controlled by using memory locations 130, 131, 145, 155, 156, 157, 158, 159, and 129; that is, by supplying the PCM bus time-slot addresses, switching the SLIC into the proper mode, and activating the codec. Within memory location 129, the codec would normally be placed into active mode, with both directions of the PCM bus enabled at the start of a call. At the completion of a call, the codec should be placed into standby mode and the PCM bus disabled. Great caution should be used when changing the memory while the codec is in active mode, since termination impedances, balance impedances, and gains may change. These changes are likely to yield undesirable system effects. It is safe to refresh coefficients that are known to be unchanging in the application. It is always possible to read the memory to verify its contents without deleterious effects on codec operation. Normal operation would load the memory and perform all gain adjustments while the codec is in standby mode. Under no circumstances should memory above address 162 be written, since this section of memory is used for state data and intermediate results. Also, all reserved addresses should not be written. Changing this information may have deleterious effects on system operation.

Signal Processing

Figure 18 details the signal processing functional blocks of one channel of the codec.



^{*} Programmable blocks.

Figure 18. Internal Signal Processing

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational section of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Table 4. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Storage Temperature Range	Tstg	- 55	150	°C
Power Supply Voltage (all pins designated power)	VDDX	_	6.5	V
Negative Voltage on Any Pin with Respect to Ground	Vss	-0.25	_	V
Thermal Resistance, Junction to Ambient		_	30	°C/W
SLIC Control Interface Latches, Current per Channel	lι	1	25	mA

Recommended Operating Ranges

Table 5. Recommended Operating Ranges

Parameter	Symbol	Min	Max	Unit
Ambient Operating Temperature	TA	-40	85	°C
Operating Junction Temperature	TJ	-40	125	°C
Power Supply Voltage (all leads desiganted power)		4.75	5.25	V

Handling Precautions

Although protection circuitry has been designed into this device, proper precautions should be taken to avoid exposure to electrostatic discharge (ESD) during handling and mounting. Agere Systems Inc. employs a human-body model (HBM) and a charged-device model (CDM) for ESD susceptibility testing and protection design evaluation. ESD voltage thresholds are dependent on the circuit parameters used to define the model. No industry-wide standard has been adopted for the CDM. A standard HBM (resistance = 1500 Ω , capacitance = 100 pF) is widely accepted and can be used for comparison. The HBM ESD threshold of >1000 V was obtained by using these circuit parameters:

Table 6. Handling Precautions

HBM ESD Threshold Voltage				
Device Voltage				
T8534	>2000			

Electrical Characteristics

For all specifications: $T_A = -40 \,^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$, $V_{DD} = 5 \,^{\circ}\text{V} \pm 5\%$, unless otherwise noted. Typical values are for $T_A = 25 \,^{\circ}\text{C}$ and $V_{DD} = 5 \,^{\circ}\text{V}$ with single channel operation. Input signal frequency is 1004 Hz, unless otherwise noted.

dc Characteristics

Table 7. dc Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Voltage Low	VIL	All inputs	_	_	0.8	V
Input Voltage High	ViH	All inputs	2.0			V
Input Current	lıL	Digital, without pull-up, inputs, GND < VIN < VDD	-10		10	μΑ
		With internal pull-up, VIN = GND (INTS, MCLK, and RST pins)	-240	_	10	μΑ
		With internal pull-up, VIN = VDD (INTS, MCLK, and RST pins)	–10	_	10	μΑ
Output Voltage Low	Vol	I∟ = 3.2 mA			0.4	V
Output Voltage High	Vон	IL = -320 μA	3.5			V
Output Current in High-impedance State	loz	GND < Vout < Vdd	-30		30	μΑ
Line Driver (DX and DO pins) Output Voltage High	Voн	I∟ = −10 mA	VDD - 0.5	_		V
Line Driver (DX and DO pins) Output Voltage Low	Vol	IL = 10 mA		_	0.5	V

Analog Interface

The following specifications pertain to the analog SLIC interface for each channel.

Table 8. Analog Interface

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Resistance	Rvfxi	0.25 < VIN < (VDDX - 0.25) V	100		300	kΩ
Input Voltage	Vıx	Relative to ground Signal should be capacitively coupled to VFxI	1.8	2.0	2.2	V
Load Resistance at VFROP and VFRON (differential)	R∟	RL RL S-8881F	7.5			kΩ
Output Resistance	Ro	Digital input code corresponding to idle PCM code (μ-law)		2	10	Ω
Output Offset Voltage Between VFROP and VFRON	Vos	Digital input code corresponding to idle PCM code (μ-law)	-100	0	100	mV
Output Offset Voltage Between VFROP and VFRON, Standby Mode	Voss	RL = 100 kΩ	-20	0	20	mV
Common-mode Output Voltage, Active Mode	Vосм	Digital input code corresponding to alternating \pm zero μ -law PCM code. RL = 7.5 k Ω	1.8	2.0	2.2	V
Common-mode Output Voltage, Standby Mode	Vocms	RL = 100 kΩ	1.7	2.0	2.3	V

Table 9. Power Dissipation

Power measurements are made at BCLK = 2.048 MHz, DCLK = 2.048 MHz, no inputs from serial interface, interface latches set as outputs, and outputs unloaded.

Parameter	Symbol	Min	Тур	Max	Unit
Power Supply Current, VDD + VDDX:					
All Channels in Standby, Dissipation for One Channel	IDDS	_	45	55	mW
Four Channels Active, Dissipation for One Channel		_	130	150	mW
One Channel Active, Dissipation for Active Channels	IDD1	_	300	_	mW

Transmission Characteristics

Table 10. Transmission Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Absolute Levels	GAL	Maximum 0 dBm0 levels (1004 Hz): VFxI (encoder milliwatt), all program- mable transmit gains set to 0 dB		2.80		Vp-p
		RCV (decoder milliwatt), termination impedance off, all programmable receive gains set to 0 dB	I	5.29		Vp-p
		Minimum 0 dBm0 levels (1004 Hz): VFxI (encoder milliwatt) XAG = 24 dB GTX1 = 6 dB GTX2 = 0 dB	_	87.5	-	mVp-p
		RCV (decoder milliwatt), termination impedance off GRX1 = 0 dB GRX2 = -6 dB	_	2.63	_	Vp-p
Absolute Maximum Voltage Swings	GAL	VFxI VFrOP to VFrON (differential)	_	_	3.2 5.28	Vp-p Vp-p
Transmit Gain Absolute Accuracy	GXA	Transmit gain programmed for maximum 0 dBm0 test level, measured deviation of digital code from ideal 0 dBm0 level at DX digital outputs, with transmit gain set to 0 dB: 20 °C to 70 °C 0 °C to 85 °C -40 °C to +85 °C	 _0.25 _0.30	±0.15 — —	 0.25 0.30	dB dB dB
Transmit Gain Variation with Programmed Gain	GXAG	Measured transmit gain over the range from maximum to minimum, calculated deviation from the programmed gain relative to GXA at				
		0 dB, Vdd = 5 V	-0.1	_	0.1	dB

Transmission Characteristics (continued)

Table 10. Transmission Characteristics (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Transmit Gain Variation with Frequency, 600 Ω	GXAF	Relative to 1004 Hz, minimum gain < GX < maximum gain, VFxI = 0 dBm0 signal, path gain set to 0 dB:				
Resistive Source Impedance and Synthesized Termination Impedance		f = 16.67 Hz f = 40 Hz f = 50 Hz f = 60 Hz f = 200 Hz f = 300 Hz to 3000 Hz f = 3140 Hz f = 3380 Hz f = 4000 Hz f = 4600 Hz	 -0.125 -0.57 -0.735	-50 -40 -40 -55 -3.5 ±0.04 0.01 -0.03	-30 -26 -30 -30 0 0.125 0.125 0.015 14 -32	dB dB dB dB dB dB dB dB
Transmit Gain Variation with Signal Level	GXAL	Sinusoidal test method *, reference level = 0 dBm0 †: VFxI = -40 dBm0 to +3 dBm0 VFxI = -50 dBm0 to -40 dBm0 VFxI = -55 dBm0 to -50 dBm0	-0.25 -0.50 -1.40		0.25 0.50 1.40	dB dB dB
Receive Gain Absolute Accuracy	GRA	Receive gain programmed to -6 dB, apply 0 dBm0 signal to DR, measure VRCV, RL = 100 k Ω differential: 20 °C to 70 °C 0 °C to 85 °C -40 °C to +85 °C	 -0.25 -0.30	±0.15 —	— 0.25 0.30	dB dB dB
Receive Gain Variation with Programmed Gain	GRAG	Measure receive gain over the range from maximum to minimum setting, calculated deviation from the programmed gain relative to GRA at 0 dB, VDD = 5 V	-0.1		0.1	dB
Receive Gain Variation with Frequency, 600 Ω Resistive Termination	GRAF	Relative to 1004 Hz, digital input = 0 dBm0 code, minimum gain < GR < maximum gain, 0 dB path gain: f = below 3000 Hz f = 3140 Hz f = 3380 Hz f = 4000 Hz f = 4600 Hz	-0.125 -0.57 -0.735 	±0.04 ±0.04 -0.550 	0.125 0.125 0.015 14 –28	dB dB dB dB dB
Receive Gain Variation with Signal Level	GRAL	Sinusoidal test method *, reference level = 0 dBm0 †: IPCM digital level = -40 dBm0 to +3 dBm0 IPCM digital level = -50 dBm0 to -40 dBm0 IPCM digital level = -55 dBm0 to -50 dBm0	-0.25 -0.50 -1.40		0.25 0.50 1.40	dB dB dB

^{*} Applied to all four channels.

[†] RTZ and CTZ paths open.

Noise Characteristics

Table 11. Per-Channel Noise Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Transmit Noise, C-Message Weighted	Nxc	0 dB transmit gain [*]	_	_	18	dBrnC0
Transmit Noise, P-Message Weighted	NXP	0 dB transmit gain [*]		l	-68	dBm0p
Receive Noise, C-Message Weighted	Nrc	0 dB receive gain, digital pattern corresponding to idle PCM code, μ-law		l	13	dBrnC0
Receive Noise, P-Message Weighted	NRP	0 dB receive gain, digital pattern corresponding to idle PCM code, A-law	_		-7 5	dBm0p
Noise, Single Frequency	NRS	f = 0 kHz to 12 kHz, 0 dBm0	_	_	-28	dBm0
Power Supply Rejection, Transmit	PSRx	$V_{DD} = 5.0 \text{ Vpc} + 100 \text{ mVrms}$ $f = 0 \text{ kHz to } 4 \text{ kHz}$ $f = 4 \text{ kHz to } 50 \text{ kHz}$		-45 -60		dB dB
Power Supply Rejection, Receive	PSRR	Measured on VFrOP/N, VDD = 5.0 VDC + 100 mVrms: f = 0 kHz to 4 kHz f = 4 kHz to 25 kHz f = 25 kHz to 50 kHz		-60 -45 -30		dB dB dB
Spurious Out-of-Band Signals at the Channel Outputs	SOS	0 dBm0, 300 Hz to 3400 Hz signal applied to VVFxI, transmit gain set to 0 dB: 4600 Hz to 7600 Hz 7600 Hz to 8400 Hz 8.4 kHz to 50 kHz		_ _ _	-30 -40 -30	dB dB dB

^{*} RVFXI = 20 M Ω .

Distortion and Group Delay

Table 12. Distortion and Group Delay

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Signal to Total Distortion,		Sinusoidal test method level:				
Transmit or Receive	STDx	μ-law, –30 dBm0 to 3 dBm0	36		_	dB
	STDR	A-law, -30 dBm0 to 3 dBm0	35		_	dB
		μ-law, -40 dBm0 to -30 dBm0	31	_	_	dB
		A-law, -40 dBm0 to -30 dBm0	30	_	_	dB
		μ-law, -45 dBm0 to -40 dBm0	27	_	_	dB
		A-law, -45 dBm0 to -40 dBm0	25	_	_	dB
Single Frequency Distortion,	SFDx	0 dBm0 single frequency input,	_	_	-46	dB
Transmit		200 Hz ≤ fin ≤ 3400 Hz; measured				
		at any other single frequency				
Single Frequency Distortion,	SFDR	0 dBm0 single frequency input,	_	_	-46	dB
Receive		200 Hz ≤ fin ≤ 3400 Hz; measured				
		at any other single frequency				
Intermodulation Distortion	IMD	Transmit or receive, two	_	_	-49	dB
		frequencies in the range of				
		300 Hz to 3400 Hz				
TX Group Delay, Absolute*	Dxa	f = 1600 Hz, 600 Ω	_	_	370	μs
_		resistive termination				
RX Group Delay, Absolute*	Drx	f = 1600 Hz, 600 Ω	_	_	220	μs
		resistive termination				

^{*} Absolute group delay is a function of time-slot assignment, and the maximum in this table refers to the (optimal minimum group delay) time-slot assignment.

Crosstalk

Table 13. Crosstalk

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Transmit to Transmit Crosstalk,	CTx-x	f = 300 Hz to 3400 Hz,				
0 dBm0 Level		any channel to any channel	_		-80	dB
Transmit to Receive Crosstalk,	CTx-R	f = 300 Hz to 3400 Hz,				
0 dBm0 Level		any channel to any other channel	_		-80	dB
		In-channel	_	_	-50	dB
Receive to Transmit Crosstalk,	CT _{R-X}	f = 300 Hz to 3400 Hz,				
0 dBm0 Level		any channel to any other channel	_	_	-80	dB
		In-channel	_		-50	dB
Receive to Receive Crosstalk,	CT _{R-R}	f = 300 Hz to 3400 Hz,	_	_	-80	dB
0 dBm0 Level		any channel to any channel				

Timing Characteristics

Table 14. Timing Characteristics

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
fdclk	Serial Bus Clock Frequency	_	_	_	4096	kHz
fBCLK	Allowable PCM Bus Clock Fre-	_	_	256	_	kHz
	quencies* (512 kHz minimum		_	512	_	kHz
	if linear encoding is selected.)		_	1024	_	kHz
			_	2048	_	kHz
			_	4096	_	kHz
				8192	_	kHz
			_	16384	_	kHz
_	BCLK Frequency Deviation	_		_	100 ns in 100 ms = 1 ppm	
_	PCM Bus Clock Duty Cycle	_	40	50	60	%
tcssetup	Chip Select Setup Time, Normal Mode	Serial clock frequency = 4.096 MHz	7	_	_	ns
tcshold	Chip Select Hold Time, Normal Mode	Serial clock frequency = 4.096 MHz	4	_	_	ns
tsxdly	Serial Bus Output Data Delay, Normal Mode	Serial clock frequency = 4.096 MHz	_	_	9	ns
tsdhold	Serial Bus Input Data Hold Time, Normal Mode	Serial clock frequency = 4.096 MHz	4	_	_	ns
tsdsetup	Serial Bus Input Data Setup Time, Normal Mode	Serial clock frequency = 4.096 MHz	7	_	_	ns
trssetup	Frame Strobe Setup Time	PCM clock frequency = 16.384 MHz	7	_	_	ns
tfshold	Frame Strobe Hold Time	PCM clock frequency = 16.384 MHz	4	_	_	ns
tfswidth	Frame Strobe Width	FS synchronous with BCLK	tBCLK	_	125 μs – tвсικ	ns
txdly	PCM Bus Output Data Delay	PCM clock frequency = 16.384 MHz	_	_	9	ns

^{*} PCM clock (BCLK) must be synchronous with both FS and MCLK, if used. If MCLK is used, then the rising edge of MCLK must coincide with the rising edge of BCLK within 10 ns.

[†] The tsxbdly delay is from either DCLK or CS, whichever transition is later, for the first bit of the byte.

Timing Characteristics (continued)

Table 14. Timing Characteristics (continued)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
tidhold	PCM Bus Input Data Hold Time	PCM clock frequency = 16.384 MHz	4	_		ns
tidsetup	PCM Bus Input Data Setup Time	PCM clock frequency = 16.384 MHz	7	_	_	ns
trise	Clock Edge Rise Time	Serial clock frequency = 4.096 MHz, PCM clock frequency = 16.384 MHz			8	ns
tfall	Clock Edge Fall Time	Serial clock frequency = 4.096 MHz, PCM clock frequency = 16.384 MHz	_	_	8	ns
trise, tfall	Line Driver Rise/Fall Time (DO and DX outputs)	IL = 15 mA, CLOAD = 100 pF		_	30	ns
tcsbhold	Chip Select Hold Time, Byte-by- Byte Mode	Serial clock frequency = 4.096 MHz	4	_	_	ns
tsxbdly	Serial Bus Output Data Delay, Byte-by-Byte Mode	Serial clock frequency = 4.096 MHz [†]	_	_	9	ns
tcsbsetup	Chip Select Setup Time, Byte- by-Byte Mode	Serial clock frequency = 4.096 MHz	7	_	_	ns
tsdbhold	Serial Bus Data Hold Time, Byte-by-Byte Mode	Serial clock frequency = 4.096 MHz	4	_	_	ns
tsdbsetup	Serial Bus Data Setup Time, Byte-by-Byte Mode	Serial clock frequency = 4.096 MHz	7	_	_	ns
tcsbhold	Chip Select Hold Time, Byte-by- Byte Mode	Serial clock frequency = 4.096 MHz	4	_	_	ns

^{*} PCM clock (BCLK) must be synchronous with both FS and MCLK, if used. If MCLK is used, then the rising edge of MCLK must coincide with the rising edge of BCLK within 10 ns.

Table 15. Echo Canceller Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Echo Return Loss	_		_	45	_	dB
Convergence Time			_	100+		dB/s

[†] The tsxbdly delay is from either DCLK or CS, whichever transition is later, for the first bit of the byte.

Bus Timing Diagrams

Normal Mode

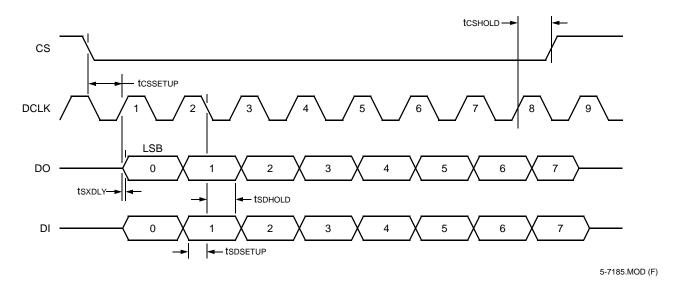


Figure 19. Serial Interface Timing, Normal Mode (One Byte Transfer Shown)

Byte-by-Byte Mode

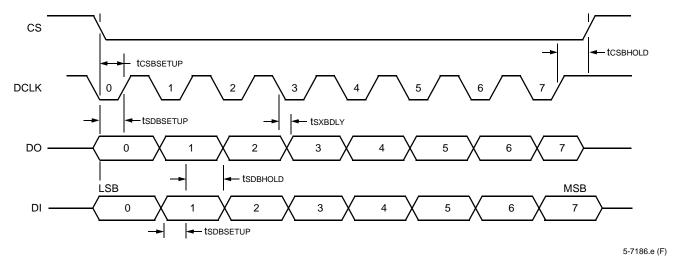


Figure 20. Serial Interface Timing, Byte-by-Byte Mode (One Byte Transfer and Gapped DCLK Shown)

Bus Timing Diagrams (continued)

PCM Interface

Only the first time slot is shown, and the bit offset is assumed to be zero. Notice that the PCM bus transfers the most significant bit of the time slot first, consistent with normal telephony practice. The diagram shows a bit offset of zero from frame strobe, and for nonzero values of RXBITOFF and TXBITOFF, the relationship between FS and DX or DR will be shifted by the programmed number of cycles of BCLK. BCLK can be any value from 256 kHz (four time slots) to 16.384 MHz (256 time slots). The frame strobe signal is at a rate of 8 kHz and **must** be synchronous with the PCM bus clock (BCLK). Sixteen-bit linear code uses two consecutive time slots with LSB transmitted/received first. See the Clocking Considerations section for the relationship between BCLK and MCLK, if used.

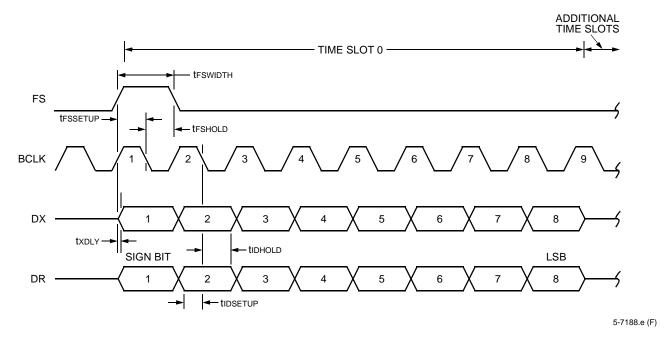


Figure 21. PCM Bus Timing (Diagram Shown Has Bit Offset of Zero and Minimum Width of FS)

Software Interface

Table 16. Memory Mapping

With the exceptions noted, all of these memory locations may be read to determine the state of the controls contained therein. In the following table, bit 0 is the LSB (transmitted first on the serial interface) and bit 7 is the most significant bit of the byte. Unused bits in an address or multibyte address should be loaded as zero. All of the memory locations can be programmed on a per-channel basis.

Note that the entire coefficient set for a channel (or all four channels) may be loaded with one command.

Control Name	Address (Decimal)	Number of Bits Used	Default Value	Name/Description
HBALTAPS*	0—127	1024	See Table 17	Balance impedance tap coefficients.
RESCTRL	128	4	0x00	Reset address. Writing a 1 in the used positions causes a reset as defined by the bit definition. This reset remains in force until the bit is written as a 0.
CHACTIVE	129	1	0x00	Standby/active control.
RXBITOFF	130	3	0x00	Bit offset for receive direction.
RXOFF	131	8	(16* channel #)	Time-slot offset for receive direction.
GRX1*	132—133	11	0x0400	Control of gain affecting receive direction gain transfer.
GRX2*	134—135	11	0x01ac	Control of gain sensitive to impedance and SLIC parameter choices, receive direction.
NORMCTRL*	136	6	0x25	Peak and far-end speech detector control.
NESCTRL*	137	3	0x06	Near-end speech detector control.
LMSGAIN*	138	8	0xee	Adaptation control address.
TDETCTRL*	139	6	0x00	Data call control address.
CTZCTRL*	140—143	31	0x07ed0000	CTZ bleed coefficients.
LMSCTRL*	144	3	0x01	Adaptation leak values.
RECCTRL*	145	5	0x00	Residual echo control.
SDCTRL*	146	7	0x19	RTZ, transmit analog gain (XAG), and analog loopback controls.
SDTSI	147	7	(17* channel #)	Internal time-slot interchanger. Default sets external pins to state referenced in this data sheet.
GTX2*	148—149	12	0x0400	Control of gain affecting transmit direction gain transfer.
ZEQCTRL*	150—152	21	0x000000	Coefficients for the equalization stage that accommodates current-sensing SLICs.
GTX1*	153—154	12	0x051a	Control of gain sensitive to impedance and SLIC parameter choices, transmit direction.
TXBITOFF	155	3	0x00	Bit offset for transmit direction.
TXOFF	156	8	(16* channel #)	Time-slot offset for transmit direction.
PCMCTRL	157	7	0x00	PCM control address.
SLICTS	158	6	0x0c	SLIC 3-state control address. A 1 enables the corresponding SLIC pin to operate as an output pin.

^{*} The coefficients to be entered can be obtained from the Aquarium coefficient software.

Table 16. Memory Mapping (continued)

Control Name	Address (Decimal)	Number of Bits Used	Default Value	Name/Description
SLICWR	159	6	0x00	Data to be written to the SLIC latches if the corresponding bit is set in the SLICTS control word.
SLICRD	160	6	_	Current actual state of the SLIC pins. This will be the same as SLICWR for those pins configured as outputs. All other positions will reflect the actual state of the external pin. A write operation to this word will be ignored, and within one PCM frame (125 µs), the data will be overwritten.
VERIFY	162	8	0x00	Test address for serial interface verification.
DATACALL	167	1	_	Read-only indicator of a data call in progress. Do not write this register.
_	254—255	16	_	Factory test only, do not access.

Table 17. Control Bit Definition

The following table shows the control bit assignments in the memory control addresses. In all control bit cases, the bit being set places the function into the active mode as defined in the function column.

Control Name (Address, Decimal) [Address, Hex]	Bit Assignment(s)	Function
HBALTAPS	0—1023	Balance impedance coefficients. Default value is 0x00 for all bytes except
(0—127) [0x00—0x7f]		for addresses 3 and 5, which are 0x80, and address 69, which is 0x88.
RESCTRL	4—7	Not used, load as 0s.
(128)	3	A one resets the state associated with special data call processing.
[0x80]	2	A one resets the echo canceller coefficients to 0 when channel is active.
	1	A one resets all other internal states. Does not affect programmed registers.
	0	Reset all control addresses to default values. Note that setting this bit will result in it and all others of this word becoming cleared on the next PCM frame as a normal part of this control reset functionality. Also, the state reset bits (1—3) are cleared before they are acted upon if this bit is raised; hence, it is not possible to reset both state and control by writing 0x0F to RESCTRL. If such an action is desired, it is necessary to first reset control by writing 0x01 and then, in a subsequent frame, write first 0x0E and then 0x00. Alternatively, hardware reset can be used to reset all control and state. It is necessary to wait at least 256 µs after asserting this bit before initiating any other serial I/O transactions.
CHACTIVE	1—7	Load as 0s.
(129) [0x81]	0	Active/Standby mode. A 0 causes the channel to enter standby (low power) mode and disables the PCM interface for this channel. A 1 activates the channel and the corresponding PCM bus interface. Default is 0.

Table 17. Control Bit Definitions (continued)

Control Name	Bit	Function						
(Address, Decimal)	Assignments							
[Address, Hex]								
RXBITOFF (130)	5—7	Receive direction bit offset for the FS signal. Do can be thought of as the least significant bits (F						
[0x82]		significant bits) of a bit counter that determines						
[UNUZ]		of the PCM data from FS.	110 1	oodii	JII 01	the mot bit		
	0—4	Load as 0.						
RXOFF	0—7	Receive time-slot assignment. Defaults to (16)						
(131)		time slot represents 8 bits, allow for two time sl	ots w	hen ι	using	j linear		
[0x83]	0 10	mode.				. () (
GRX1 (132—133)	0—10	Gain adjustment for gain transfer stage in rece 0x0400 (0 dB). This is an 11-bit multiply operati						
[0x84—0x85]		2 (6 dB). 0 dB is the maximum recommended s			Παλιι	num gam or		
GRX2	0—10	Gain adjustment for tweak gain stage in receive			. Def	aults to		
(134—135)		0x01ac (-7.58 dB). This is an 11-bit multiply op				maximum		
[0x86—0x87]		gain of 2 (6 dB). 0 dB is the maximum recomm	ende	d sett	ing.			
NORMCTRL	6—7	Load as 0s.						
(136)	3—5	Peak detector tweaking control. Use default		Num	ber	Function		
[88x0]		of 4.	5	4	3	(dB)		
			0	0	0	0.0		
			0	0	1	-3.01		
			0	1	0	-6.02		
			0	1	1	-9.03		
			1	0	0	-12.04		
			1	0	1	-15.05		
			1	1	0	-18.06 -21.07		
	0—2	Far-end speech detector threshold. Use		Num		Function		
		default of 5.	2	1	0	(dBm0)		
			0	0	0	–57		
			0	0	1	-54		
			0	1	0	-51		
			0	1	1	-48		
			1	0	0	-45		
			1	0	1	-42		
			1	1	0	-39		
			1	1	1	-36		

Table 17. Control Bit Definitions (continued)

Raddress, stext Sergiments Raddress, stext Sergiments Raddress, stext Sergiments Raddress, stext Sergiments Rescription Sergiments Sergimen	Control Name (Address, Decimal)	Bit Assignments	Function							
NESCTRL (137) 2	1 .	Assignments								
Threshold for the near-end speech detector. Default is 2 (-6 dB). Sit Number Tunction (dB)		3—7	Load as 0s.							
Total Content Total Conten	(137)	2	Enable near-end speech detector. Defaults	s to 1 (active).						
LMSGAIN (138) [0x8a] 6—7 Length of echo canceller (8, 16, 32, 64 taps). Defaults to 3 (64 taps).	[0x89]	0—1	I •							
LMSGAIN (138) [0x8a] 6—7 Length of echo canceller (8, 16, 32, 64 taps). Defaults to 3 (64 taps). Bit Number 7 6			tor. Delaure is 2 (o db).			(ii conoid =)			
LMSGAIN (138) [0x8a]							0.0			
LMSGAIN (138) [0x8a] Ength of echo canceller (8, 16, 32, 64 taps). Elit Function Number T 6 0 0 8 taps 0 1 16 taps 1 0 0 32 taps 1 0 64 taps 1 0 0 32 taps 1 1 0 64 taps 1 1 0 0 00 0 0 0 0 0 0 0 0 0 0 0 0 0										
LMSGAIN (138)				1	0		-6.0			
(138)				1	1		-9.5			
[0x8a]	LMSGAIN	6—7	Length of echo canceller (8, 16, 32, 64	Е	Bit	ı	Function			
3—5 Relative adaptive gain of the two IIR taps in the echo canceller. Defaults to 5. A setting of 0 provides no adaptive loop gain. 0—2 Loop gain for adaptation algorithm. Default is 6. Bit Number Function (Gain =) 0 0 0 0 0.0078 0 0 1 0.00156 0 1 0 0.0313 0 1 1 0.0625 1 0 0 0 0.1250 1 0 1 0.05000 1 1 1 0.05000 1 1 1 0.05000 1 1 1 0.05000 1 1 1 1 0.00000 1 1 1 1 0.000000 1 1 1 1 0.0000000000	` ,		taps). Defaults to 3 (64 taps).							
0	[0x8a]									
1										
1							•			
Comparison of the two IIR taps in the echo canceller. Defaults to 5. A setting of 0 provides no adaptive loop gain. Comparison of the two IIR taps in the echo canceller. Defaults to 5. A setting of 0 provides no adaptive loop gain. Comparison of the two IIR taps in the echo canceller. Defaults to 5. A setting of 0 provides no adaptive loop gain. Comparison of Comparison					0	•				
to 5. A setting of 0 provides no adaptive loop gain. O-2		2 5	Polotive adaptive gain of the two IIP tops in		obo o	ongol	•			
Default is 6. Bit Number Function (Gain =)		ა—ა				ancei	ilei. Deiaulis			
Default is 6. 2 1 0 (Gain =)		0—2				ber	Function			
0			Default is 6.	2	1	0	(Gain =)			
O 1 0 0.0313 O 1 1 0 0.0313 O 1 1 0 0.0625 1 0 0 0 0.1250 1 0 1 0.2500 1 1 0 0.5000 1 1 1 0 0.5000 1 1 1 1 0.05000 1 1 1 1 1 0.005000 1 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 1 1.000 1 1 1 0.02500 1 1 1 0 0.12500 1 1 1 0 0.12500 1 1 1 0 0.12500 1 1 1 0 0.12500 1 1 1 0 0.12500 1 1 1 0 0.0313 1 1 1 0.0625 1 1 0 0 0.0313 1 1 1 0.0625 1 1 0 0 0.0313 1 1 1 0.0625 1 0 0 0.1250 1 1 1 0 0.0625 1 0 0 0.0313 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.0313 1 0 0 0 0.0313 0 0 0 0 0.1250 1 0 0 0 0.0313 0 0 0 0 0.1250 1 0 0 0 0.0250 1 0 0 0 0.0313 1 0 0 0 0.0313 1 0 0 0 0 0.1250 1 0 0 0 0.0313 1 0 0 0 0 0.1250 1 0 0 0 0.0313 1 0 0 0 0 0.1250 1 0 0 0 0 0.1250 1 0 0 0 0.0313 1 0 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.1250 1 0 0 0 0.0250 1 0 0 0 0 0.0250 1 0 0 0				0	0	0	0.0078			
TDETCTRL (139) [0x8b] 5 This bit being set allows the echo canceller coefficients developed offline during a data call to be captured and saved for potential use during the next data call. Default is 0 (do not capture). 3 This bit, when set, enables the use of the internal logic to determine the proper time for the off-line adaptation during a data call. Default is 0. 2 Selects the internal set of hybrid balance network coefficients to use on a data call. Default is 0. 1 This bit, when set to a 1, clears the H register at the start of a data call. Default is 0.				0	0	1	0.0156			
TDETCTRL (139) [0x8b] 5 This bit being set allows the echo canceller coefficients developed offline during a data call to be captured and saved for potential use during the next data call. Default is 0 (do not capture). 4 This bit enables the echo canceller to continue to adapt during a data call. Default is 0 (do not adapt during a data call). 3 This bit, when set, enables the use of the internal logic to determine the proper time for the off-line adaptation during a data call. Default is 0. 2 Selects the internal set of hybrid balance network coefficients to use on a data call. Default is 0. 1 This bit, when set to a 1, clears the H register at the start of a data call. Default is 0.				0	1	0	0.0313			
TDETCTRL (139) [0x8b] 6—7 Load as 0. This bit being set allows the echo canceller coefficients developed offline during a data call to be captured and saved for potential use during the next data call. Default is 0 (do not capture). 4 This bit enables the echo canceller to continue to adapt during a data call. Default is 0 (do not adapt during a data call). 3 This bit, when set, enables the use of the internal logic to determine the proper time for the off-line adaptation during a data call. Default is 0. 2 Selects the internal set of hybrid balance network coefficients to use on a data call. Default is 0. 1 This bit, when set to a 1, clears the H register at the start of a data call. Default is 0.				0	1	1				
TDETCTRL (139) [0x8b] 5 This bit being set allows the echo canceller coefficients developed off-line during a data call to be captured and saved for potential use during the next data call. Default is 0 (do not capture). 4 This bit enables the echo canceller to continue to adapt during a data call. Default is 0 (do not adapt during a data call). 3 This bit, when set, enables the use of the internal logic to determine the proper time for the off-line adaptation during a data call. Default is 0. 2 Selects the internal set of hybrid balance network coefficients to use on a data call. Default is 0. 1 This bit, when set to a 1, clears the H register at the start of a data call. Default is 0.					_					
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		1	This bit, when set to a 1, clears the H regis	ter at	the st	art of	a data call.			
		0		er. De	fault is	s 0.				

Table 17. Control Bit Definitions (continued)

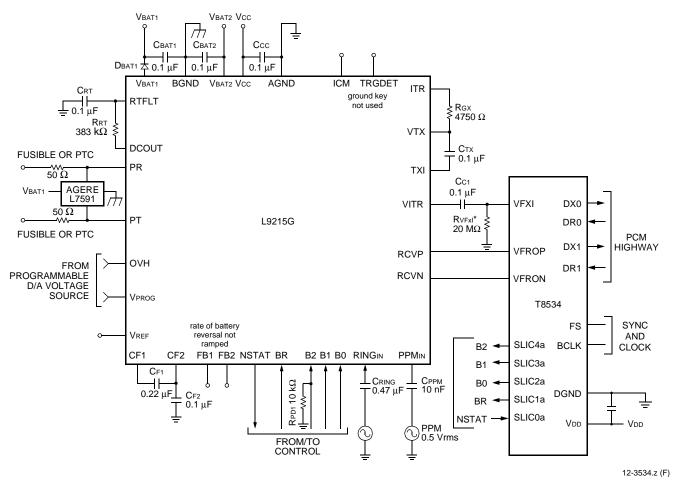
Control Name	Bit	Function									
(Address, Decimal)	Assignments										
[Address, Hex]		0 (") 1 () 1 () 1 () 1 () 1									
CTZCTRL (4.40)	0—30	Coefficients for the CTZ termination bleed. Defaults to 0x07ed0000.									
(140—143) [0x8c—0x8f]											
LMSCTRL	3—7	Load as 0s.									
(144)	3—7 0—2	Leak coefficient for LMS adaptation algorithm	m D	ofaul	to to	1					
[0x90]	0—2	·	וו. ט	Ciaui	15 10	1.					
RECCTRL	5—7	Load as 0s.									
(145)	4	Noise match enable (comfort noise). Default		,		ed).					
[0x91]	3	Enable residual echo control. Defaults to 0 (,							
	0—2	Residual echo control sensitivity factor.		Nun	nber	Function					
		Defaults to 0.	2	1	0	(dB) (Threshold =)					
			0	0	0	0.0					
			0	0	1	-3.5					
			0	1	0	-6.0					
			0	1	1	-9.5					
			1	0	0	-12.0					
			1	0	1	-15.5					
			1	1	0	-18.0					
			1	1	1	-21.6					
SDCTRL	7	Load as 0.									
(146)	6	Enable analog loopback. Defaults to 0 (no									
[0x92]	3—5	RTZ gain. Defaults to 3 (equal level point val off by writing to zero.	ue o	f 3 * (0.075	5 = 0.225). Turn					
	0—2	Transmit analog gain (XAG). Defaults to 1	Bit	Nun	nber	Function					
		(6 dB) gain.	2	1	0	(dB)					
			0	0	0	0.0					
			0	0	1	6.02					
			0	1	0	12.04					
			0	1	1	18.06					
			1	0	0	24.08					
SDTSI	7	Load as 0.									
(147) [0x93]	6	Digital loopback, loopback from receive to tr				•					
[0x93]	4—5	converters (digital loopback 2). Defaults to Analog channel feeding this digital channel i	•		•	,					
	4—5	Defaults to channel number.	II UII	e liai	1511111	direction.					
	3	Send idle channel code (alternating bits) to this analog receive path.									
	J	Defaults to 0 (do not send idle channel code).									
	2	Loopback from transmit to receive at the sigma-delta converters (digital									
		loopback 3). Defaults to 0 (no loopback).									
	0—1	Digital channel feeding this analog receive channel. Defaults to channel number.									
GTX2	0—11	Gain control for gain transfer stage in transn	nit di	rection	on. D	efaults to					
(148—149)		0x0400 (0 dB). This is a 12-bit multiply opera	ation	with	a ma	aximum gain of					
[0x94—0x95]		4 (12 dB).									

Table 17. Control Bit Definitions (continued)

Control Name Bit Function		Function	
(Address, Decimal)	Assignments		
[Address, Hex]			
ZEQCTRL (150—152) [0x96—0x98]	0—20	Coefficients for the equalization stage that accommodates current-sensing SLICs. Defaults to 0x000000.	
GTX1 (153—154) [0x99—0x9a]	0—11	Gain control for tweak gain stage in transmit direction. Defaults to 0x05 (2.11 dB). This is a 12-bit multiply operation with a maximum gain of 4 (12 dB).	
TXBITOFF (155) [0x9b]	5—7	Transmit direction bit offset for the FS signal. Defaults to 0. These 3 bits can be thought of as the least significant bits (TXOFF contains the more significant bits) of a bit counter that determines the location of the first bit of the PCM data from FS.	
	0—4	Load as 0.	
TXOFF (156) [0x9c]	0—7	Transmit time-slot assignment. Defaults to (16 x channel number). Each time slot represents 8 bits, allow for two time slots when using linear mode.	
PCMCTRL (157) [0x9d]	7	3-state transmit PCM interface. Defaults to 0. A 1 forces the PCM interface into a high-impedance state during its assigned time slot on the PCM bus. Placing the channel in standby mode also forces a high-impedance condition on the transmit interface.	
	6	Transmit zeros instead of data. Defaults to 0 (off).	
	5	Load as 0.	
	4	Place idle channel code on receive path. Defaults to 0 (off).	
	3	Loopback receive to transmit at PCM conversion interface (digital loopback 1). Defaults to 0 (no loopback).	
	2	Loopback transmit to receive at PCM conversion interface (digital loopback 4). Defaults to 0 (no loopback).	
	1	Linear/companded. A 1 sets 16-bit linear mode with two adjacent time slots used, LSB transmitted first. Linear data is in two's complement form. A 0 sets companded mode with only one time slot used, and MSB transmitted first. Defaults to 0.	
	0	μ -law or A-law. A 0 sets μ -law mode, and a 1 sets A-law mode. This bit has no effect if bit 1 of this address is set to 1. Defaults to 0 (μ -law).	
SLICTS	6—7	Load as 0.	
(158) [0x9e]	0—5	Controls the drivers for the corresponding SLIC latches. A 1 enables the pin as an output. Defaults to 0x0c (bits 2 and 3 set, the rest cleared).	
SLICWR (159) [0x9f]	6—7	Load as 0.	
	0—5	SLIC data latches. If the corresponding bit in the SLICTS address is set for an output, the device will drive the corresponding bit according to the contents of this address. Writes are performed within 125 μ s. Wait 125 μ s before a subsequent write to the same channel or between write all channel commands. Default is 0.	
SLICRD (160) [0xa0]	6—7	Not used, ignore on a codec read command addressing this location.	
	0—5	Reports the actual state of the SLIC pins. Anything written to this address is ignored. Updates within 125 $\mu s.$	
VERIFY (162) [0xa2]	0—7	0—7 Test location for serial interface. This location has no internal use, but merely latches write data for the purpose of testing the serial interface. This register does not clear with reset.	
DATACALL (167) [0xa7]	5	This bit is set to a 1 if a data call is in progress. Do not attempt to write this register.	
	0—4, 6, 7	Internal state control bits; do not write and ignore on read.	

Applications

The following reference circuit shows a complete schematic for interfacing to the Agere L9215G SLIC. All ac parameters are programmed by the T8534. Note that this implementation differentiates itself in that no external components are required in the ac interface to provide a dc termination impedance or for stability. For illustration purposes, 0.5 Vrms PPM injection was assumed in this example and no meter pulse rejection is used. Also, this example illustrates the device using programmable overhead and current limit.



*RVFxI is required for complex terminations. Optional for resistive terminations.

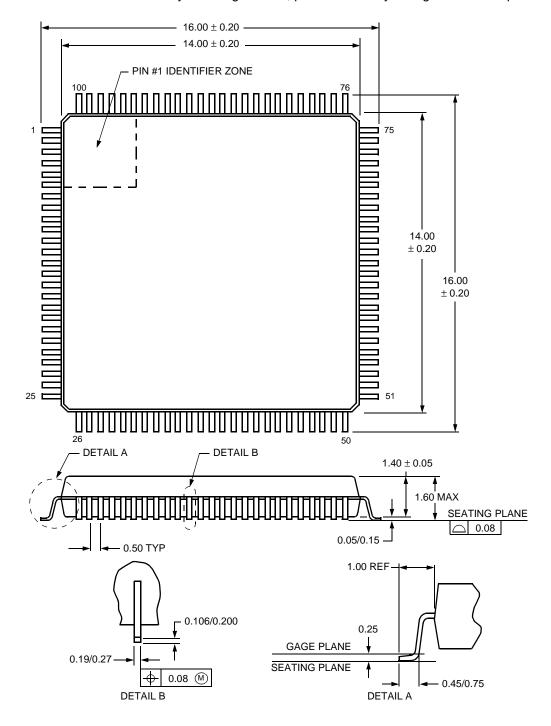
Figure 22. POTS Interface

Outline Diagrams

100-Pin TQFP

Dimensions shown are in millimeters.

Note: The dimensions in this outline diagram are intended for informational purposes only. For detailed schematics to assist your design efforts, please contact your Agere Sales Representative.



5-2146F

Ordering Information

Device Code	Package	Comcode
T-8534 1TL - DB	100-Pin TQFP, dry pack tray	700022632

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E-MAIL: docmaster@agere.com

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